



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#9/c
VASE
4/26/02

Application Serial No. 09/480,076
Filing Date January 10, 2000
Inventor Rickie C. Lake
Assignee Micron Technology, Inc.
Group Art Unit 1733
Examiner J. Haran
Attorney's Docket No. MI40-274
Title: "Method of Conductively Interconnecting Electronic Components, Battery Powerable Apparatus, Radio Frequency Communication Device, and Electric Circuit"

RESPONSE TO DECEMBER 19, 2001 OFFICE ACTION

To: Assistant Commissioner for Patents
Washington, D.C. 20231

EV077328676

From: James D. Shaurette (Tel. 509-624-4276; Fax 509-838-3424)
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Sir:

Responsive to the Office Action dated December 19, 2001, Applicant amends and

remarks as follows:

AMENDMENTS

In the Specification

Please replace the paragraph beginning at line 1 of page1 with the following clean replacement paragraph in accordance with 37 C.F.R. § 1.121(b)(1)(ii):

--RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial No. 09/022,812, filed February 12, 1998, entitled "Thin Profile Battery Bonding Method and Method of Conductively Interconnecting Electronic Components", naming Rickie C. Lake